Attorney Docket No.: 0180144

INSTHE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re Application of: Xiang, et al.

Serial No.: 10/643,461

Filed: August 18, 2003

For: Field Effect Transistor Having Increased

**Carrier Mobility** 

03/15/2005 RKELECH1 00000010 10543461

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## INFORMATION DISCLOSURE STATEMENT

Art Unit: 2815

Examiner: Nguyen, Joseph H.

Honorable Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir/Madam:

In this Information Disclosure Statement and pursuant to 37 C.F.R. §§ 1.56 and 1.97, Applicants hereby disclose to the Patent Office patents, publications or other information of which Applicants are aware. A copy of a Form 1449 identifying the patents and other materials is submitted herewith.

The items identified in this Information Disclosure Statement may or may not be "material" as defined in 37 C.F.R. § 1.56, and the submission thereof by Applicants is not to be construed as an admission that any such patent, publication or other information referred to is material or considered to be material (37 C.F.R. § 1.97(h)), or even qualifies as "prior art" under 35 U.S.C. § 102 with respect to the present invention unless specifically designated by Applicants as such. Identification of any reference or patent herein is not an admission, nor is it to be construed as an admission, that it was invented prior to the invention disclosed herein.

Attorney Docket No.: 0180144

The filing of this Information Disclosure Statement is not to be construed to mean that a search has been made or that no other material information, as defined in 37 C.F.R. § 1.56, exists.

In accordance with 37 C.F.R. § 1.97(c)(2) and §1.17, a Credit Card Payment Form PTO-2038 for \$180.00 is enclosed to cover the fee for filing this Information Disclosure Statement, since it is being filed after the mailing date of a final action. Each item of information contained in this Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

The Assistant Commissioner is hereby authorized to charge or credit Deposit Account Number 50-0731 for any deficiency or overpayment in the fees required for the filing of this Information Disclosure Statement, for which purpose a duplicate copy of this paper is also included.

> Respectfully submitted, Farjami & Farjami LLP

Dated: 3/9/05

Michael Farjami Reg. No. 38, 135

Attorneys for Applicants

Michael Farjami

FARJAMI & FARJAMI LLP 26522 La Alameda Ave., Ste. 360

Mission Viejo, CA 92691

Tel: (949) 282-1000

Fax: (949) 282-1002

CERTIFICATE OF MAILING

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- 2 -

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## **FORM PTO-1449**

ATTY. DOCKET NO. 0180144

SERIAL NO. 10/643,461

**APPLICANTS:** 

Xiang, et al.

FILING DATE: August 18, 2003

GROUP ART: 2815

## LIST OF PATENTS AND OTHER ITEMS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

(Use several sheets if necessary)

**U.S. PATENT DOCUMENTS DOCUMENT** FILING DATE SUB Exam. Initials NUMBER DATE **NAME** CLASS CLASS 7/17/2001 Marshall, et al. 6,262,462 1 2 5,721,145 2/24/1998 Kusakabe, et al. 3 2002/093046 A1 7/18/2002 Moriya, et al.

	FOREIGN PATENT DOCUMENTS										
Exam. Initials		DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY OR PATENT OFFICE	CLASS	SUB CLASS	TRANSI	NO			
	1	WO 2004/112147 A1	12/23/2004	WIPO							
	2	EP 1 164 636 A2	12/19/2001	EPO							
	3	JP 05082777	4/2/1993	ЈРО							

	OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)	
1	Ota et al, Novel Locally Strained Channel Technique for High Performance 55nm CMOS, IEDM Technical Digest, 27-30 (2002)	
2	Applying Mechanical Stress to Improve MOS Semiconductor Performance, 30 IBM Technical Disclosure Bulletin, 330-333 (1988)	
3	Momose et al, Relationship Between Mobility and Residual-Mechanical-Stress As Measured By Raman Spectroscopy For Nitrided-Oxide-Gate MOSFETs, 90 IEDM, 65-68 (1990)	
4	Jennifer O'Connor, Analytical Predictions of Thermal Stress in MOSFETs, IEEE, 131-143 (1995)	
5	Wristers et al, Ultra Thin Oxide Reliability: Effects of Gate Doping Concentration and Poly- Si/SiO2 Interface Stress Relaxation, IEEE, 77-83 (1996)	
6	Steegen et al, Silicide-induced Stress In Si: Origin and Consequences for MOS Technologies, 38 Materials Science and Engineering R: Reports, 1-53 (2002)	

EXAMINER:	DATE CONSIDERED:

EXAMINER: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to applicant.

Information Disclosure Statement-- Section 9 PTO-1449